

Package : SBGAxxxTseries

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1. Structure and materials

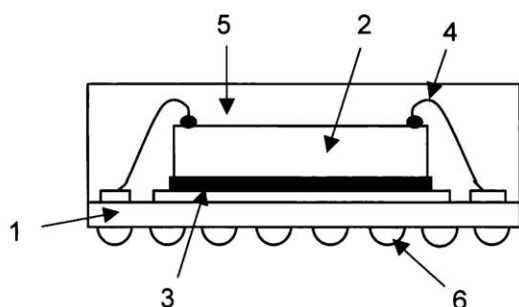


Fig. 1 Structure

No.	Item	Materials
1	Interposer	BT resin
2	Die	Silicon
3	Die Attach	Non-conductive Paste
4	Wire	Au
5	Molding	Epoxy Resin
6	External Lead	Solder Ball (Sn-3.0Ag-0.5Cu)

2. Tape and Reel information

2.1. Packing specification

Tape	Embossed carrier tape with dry pack
Quantity	See the table on page 4/4
Direction of feed	E2(See Fig. 2)

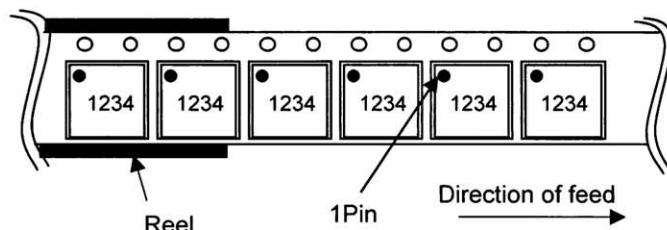


Fig. 2 Typical Tape and Reel configuration

2.2. Tape and Reel specification

2.2.1. Tape and reel dimensions (See the table on page 4/4)

SBGA024T040
 SBGA035T050
 SBGA063T060
 SBGA120T080
 SBGA195T100

SBGA099T070
 SBGA168T090

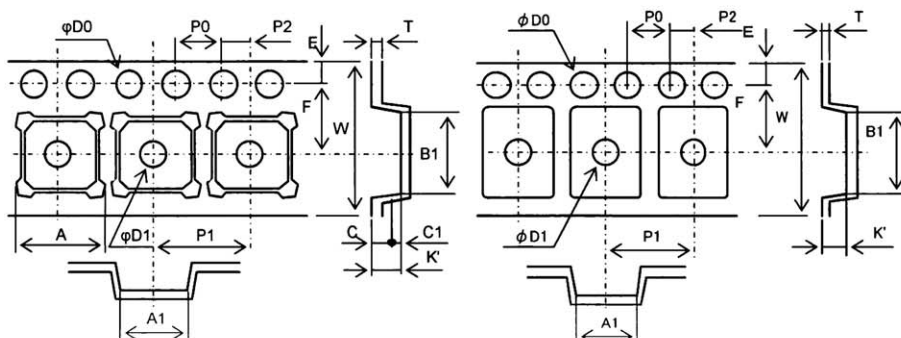


Fig. 3 Tape dimensions

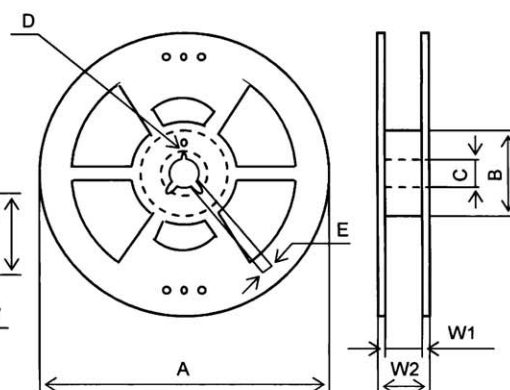


Fig. 4 Reel dimensions

2.3.Leader and Trailer

2.3.1.Leader

No component pockets are 25 pockets or more.

2.3.2.Trailer

No component pockets are 10 pockets or more.

Tape is free from reel.

2.4.Label for Reel and Box

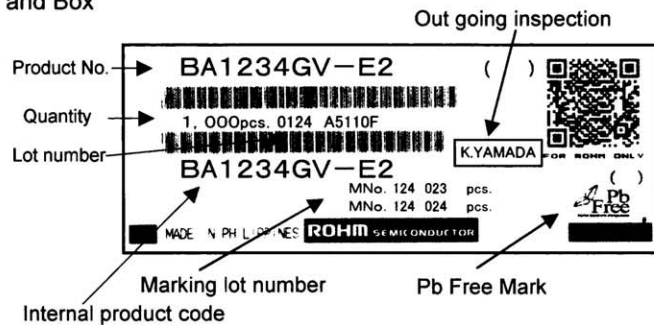


Fig. 5 Label example

2.5.Packing style

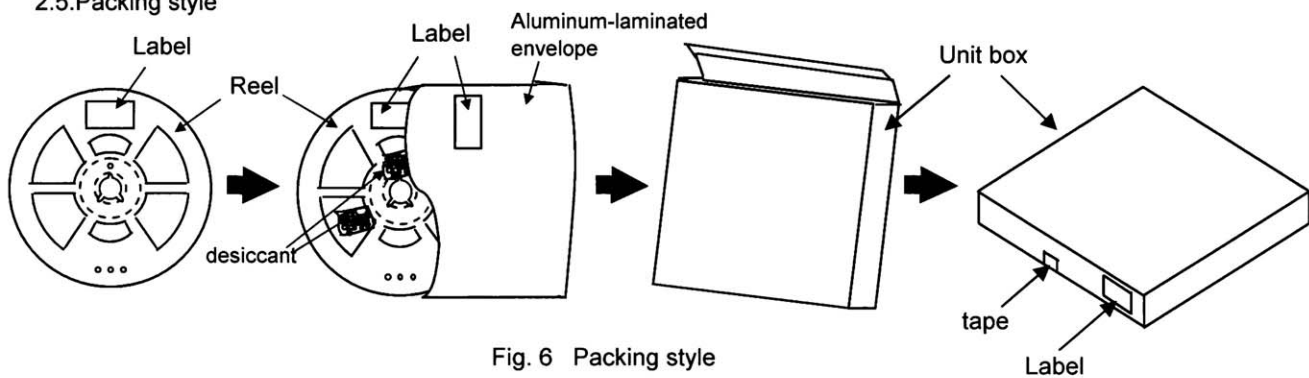
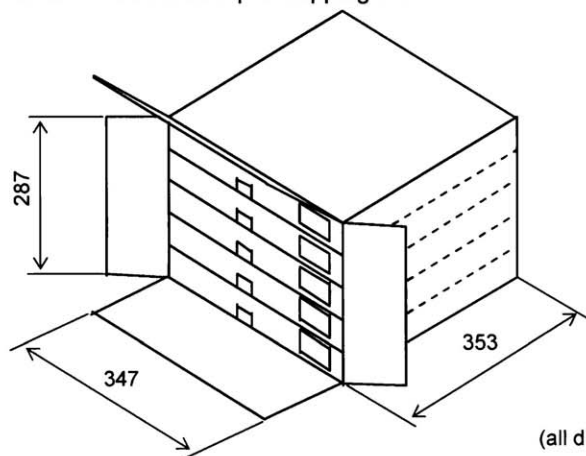


Fig. 6 Packing style

2.6.Shipping style

5 unit boxes or less per shipping box



(all dimensions in mm)

Fig. 7 Shipping box dimensions and Shipping style

2.7.Packing materials

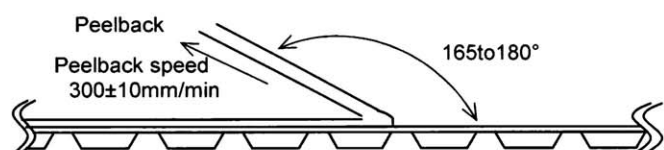
Item	Material
Embossed carrier tape	PS
Cover tape	PET + PE
Reel	PS
Desiccant	Silicagel
Envelope	Aluminume-laminated
Unit box	Cardboard
Shipping box	Cardboard

2.8.Others

2.8.1.Peelback strength

Cover tape peelback strength is 0.2to0.7N.

Fig. 8 Test method



2.8.2.Missing ICs

(1)No consecutive dropouts.

(2)A maximum 0.1% of specified number of products in each packing may be missing.

3.Storage conditions

3.1.Storage environment

Recommended storage conditions are as follows :

-Temperature :5to30

-Humidity :40to70 RH

3.2.Storage period

-Specified storage period : 1year

3.3.Specified storage period until soldering (except VBGA015T030)

Dry process before mounting is necessary in the following two case.

1.After the package is opened , the product is left unused over 168 hours.

2.Before the package is opened , the product is left in the package unused over 1year.

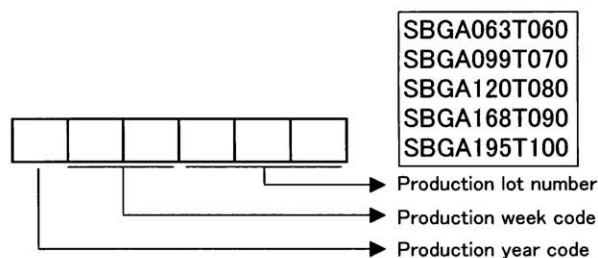
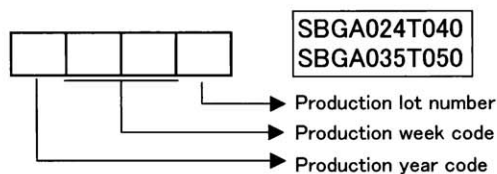
Please excute dry processing in a reel state with 60 for 48 hours.

At this time, peelback strength of cover tape become 0.2N - 0.9N.

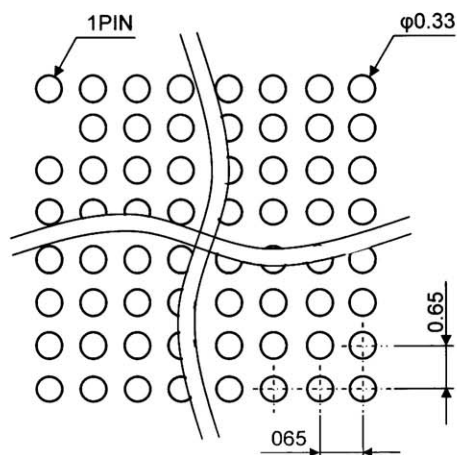
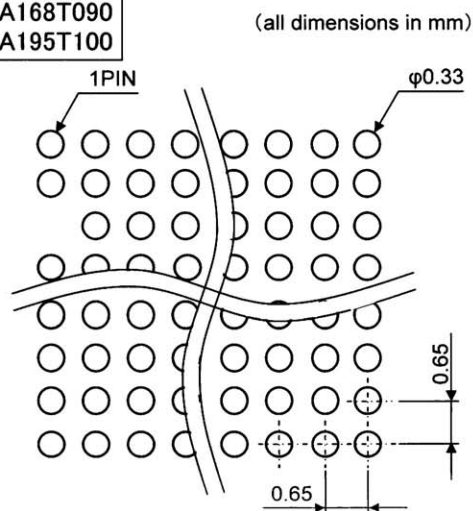
Case of transferring to heatproof container such as trays, excute dry processing with 125 for 24 hours.

In addition, the dry processing should be max, 2 times due to influence on the product's solderability.

4.Marking lot number

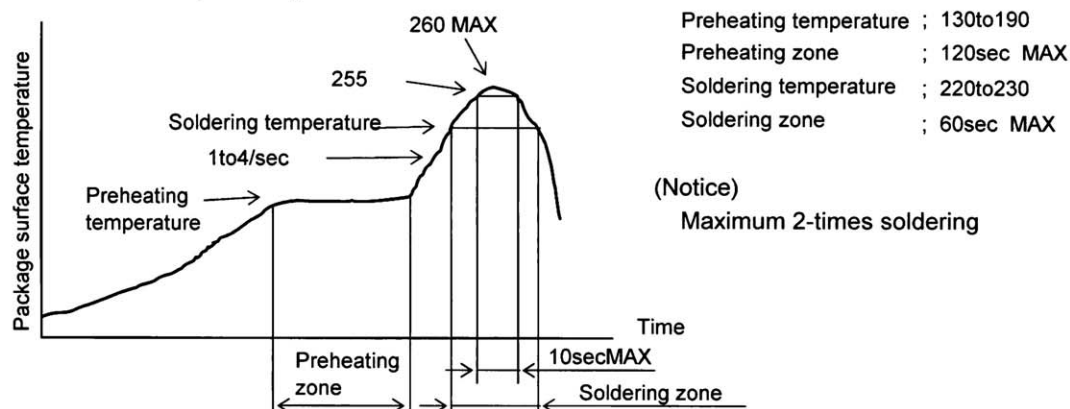


5.Footprint dimensions (Optimize footprint dimensions to the board design and soldering condition)

SBGA024T040
SBGA035T050SBGA063T060
SBGA099T070
SBGA120T080
SBGA168T090
SBGA195T100

6. Soldering conditions

6.1. Recommended temperature profile for reflow



6.2. About mounting with Sn-Pb solder paste.

Mounting with Sn-Pb solder paste is not recommended because it has a possibility of reducing reliability to connect with Sn-3.0Ag-0.5Cu solder balls.

6.3. The wave soldering method is not supported.

6.4. Underfill

To apply underfill is recommended because it has a possibility of reducing reliability to connect by drop impact or bent stress of board.

(Tape dimensions)

Package	Quantity (pcs)	Tape dimensions (all dimensions in mm)													
		A1	B1	C	C1	D0	D1	E	F	K'	P0	P1	P2	T	W
SBGA024T040	2500	4.2	4.2	(1.15)	(0.65)	φ1.5	φ1.5	1.75	5.5	1.8	4.0	8.0	2.0	0.3	12.0
SBGA035T050	2500	5.2	5.2	(1.15)	(0.65)	φ1.5	φ1.5	1.75	5.5	1.8	4.0	8.0	2.0	0.3	12.0
SBGA063T060	2500	6.2	6.2	(1.15)	(0.65)	φ1.5	φ1.5	1.75	5.5	1.8	4.0	8.0	2.0	0.3	12.0
Tolerance		±0.05	±0.05	-	-	^{+0.1} ₋₀	±0.1	±0.1	±0.05	±0.1	±0.1	±0.1	±0.05	±0.05	±0.2

Package	Quantity (pcs)	Tape dimensions (all dimensions in mm)													
		A1	B1	C	C1	D0	D1	E	F	K'	P0	P1	P2	T	W
SBGA120T080	1000	8.2	8.2	(1.15)	(0.65)	φ1.5	φ1.5	1.75	7.5	1.8	4.0	12.0	2.0	0.3	16.0
SBGA195T100	1000	10.2	10.2	(1.15)	(0.70)	φ1.5	φ1.5	1.75	7.5	1.85	4.0	12.0	2.0	0.3	16.0
Tolerance		±0.05	±0.05	-	-	^{+0.1} ₋₀	±0.1	±0.1	±0.1	±0.1	±0.1	±0.1	±0.1	±0.05	±0.3

Package	Quantity (pcs)	Tape dimensions (all dimensions in mm)													
		A1	B1	C	C1	D0	D1	E	F	K'	P0	P1	P2	T	W
SBGA099T070	1500	7.25	7.25	-	-	φ1.5	φ1.5	1.75	7.5	1.4	4.0	12.0	2.0	0.3	16.0
SBGA168T090	1000	9.35	9.35	-	-	φ1.5	φ1.5	1.75	7.5	1.45	4.0	12.0	2.0	0.3	16.0
Tolerance		±0.1	±0.1	-	-	^{+0.1} ₋₀	±0.1	±0.1	±0.1	±0.1	±0.1	±0.1	±0.1	±0.05	±0.3

(Reel dimensions)

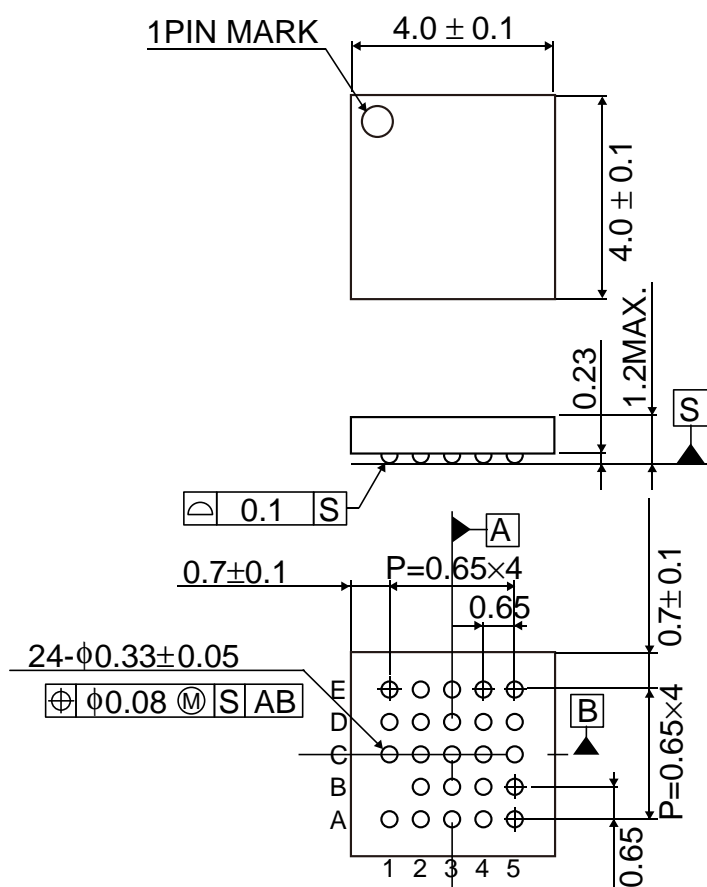
Package	Reel dimensions (all dimensions in mm)						
	A	B	C	D	E	W1	W2
SBGA024T040	φ330	50	13.0	20.2	1.5	13.4	17.4
SBGA035T050	φ330	50	13.0	20.2	1.5	13.4	17.4
SBGA063T060	φ330	50	13.0	20.2	1.5	13.4	17.4
SBGA099T070	φ330	50	13.0	20.2	1.5	17.4	21.4
SBGA120T080	φ330	50	13.0	20.2	1.5	17.4	21.4
SBGA168T090	φ330	50	13.0	20.2	1.5	17.4	21.4
SBGA195T100	φ330	50	13.0	20.2	1.5	17.4	21.4
Tolerance		-	MIN	±0.2	MIN	MIN	±1.0

(Dehydrated weight)

Dehydrated weight dimensions in g
0.03
0.05
0.08
0.10
0.14
0.18
0.22

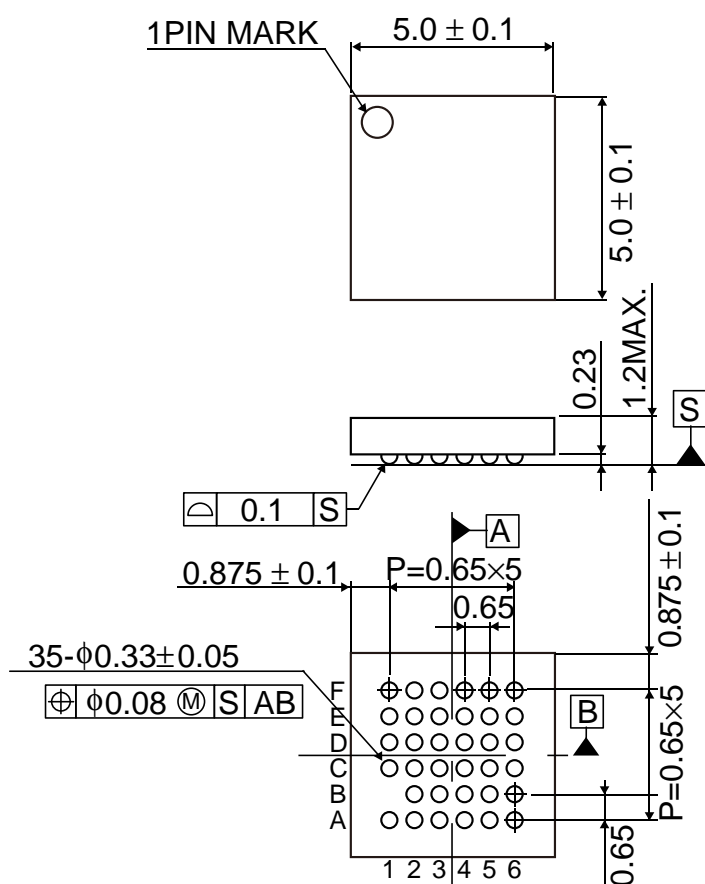
Package Dimensions

SBGA024T040



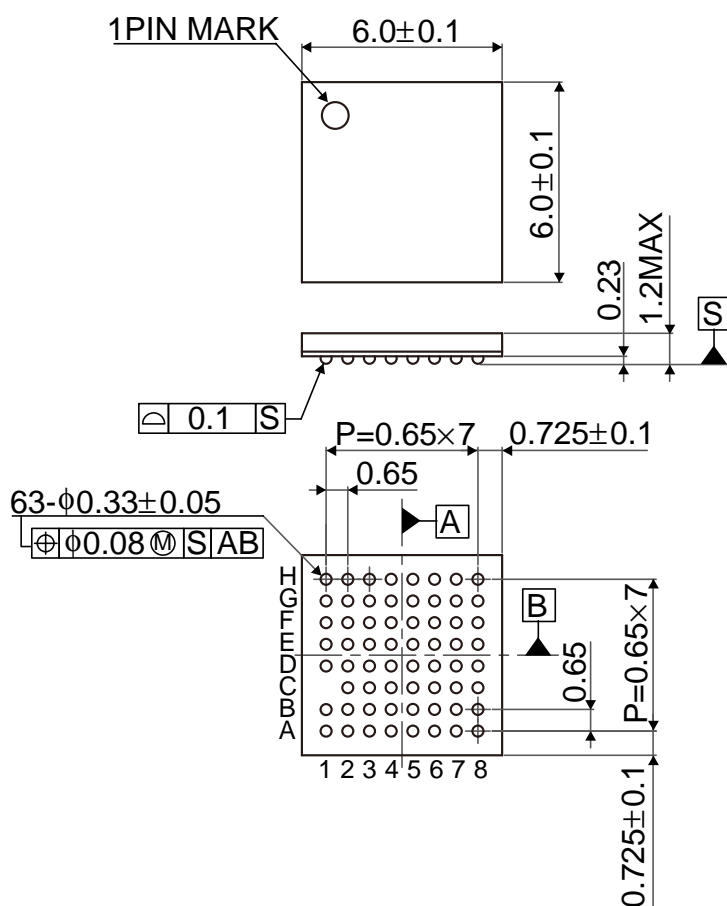
(Unit : mm)

Package Dimensions

SBGA035T050

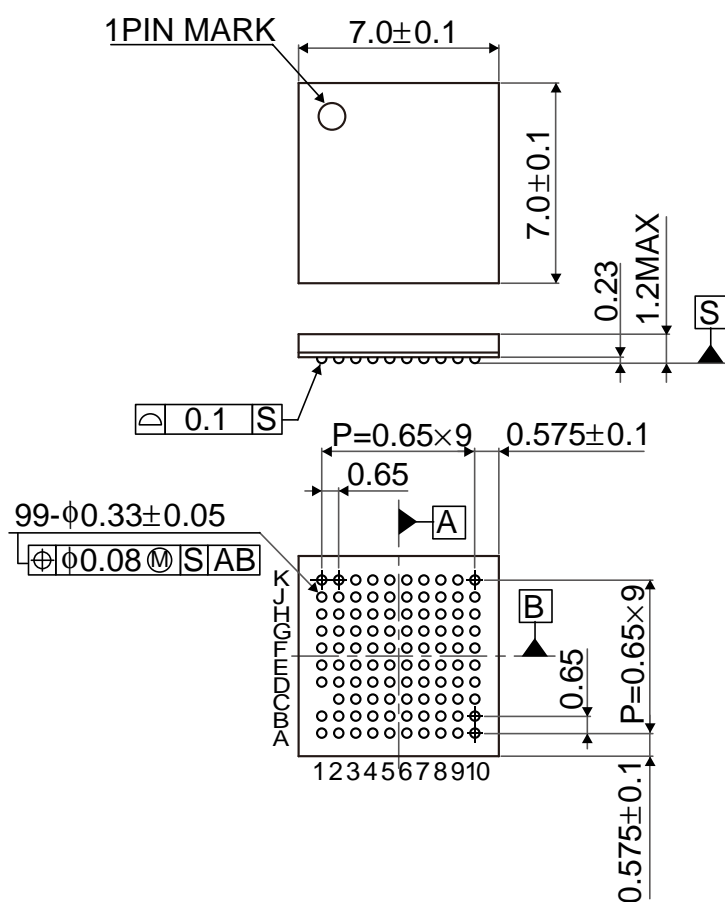
(Unit : mm)

Package Dimensions

SBGA063T060

(Unit : mm)

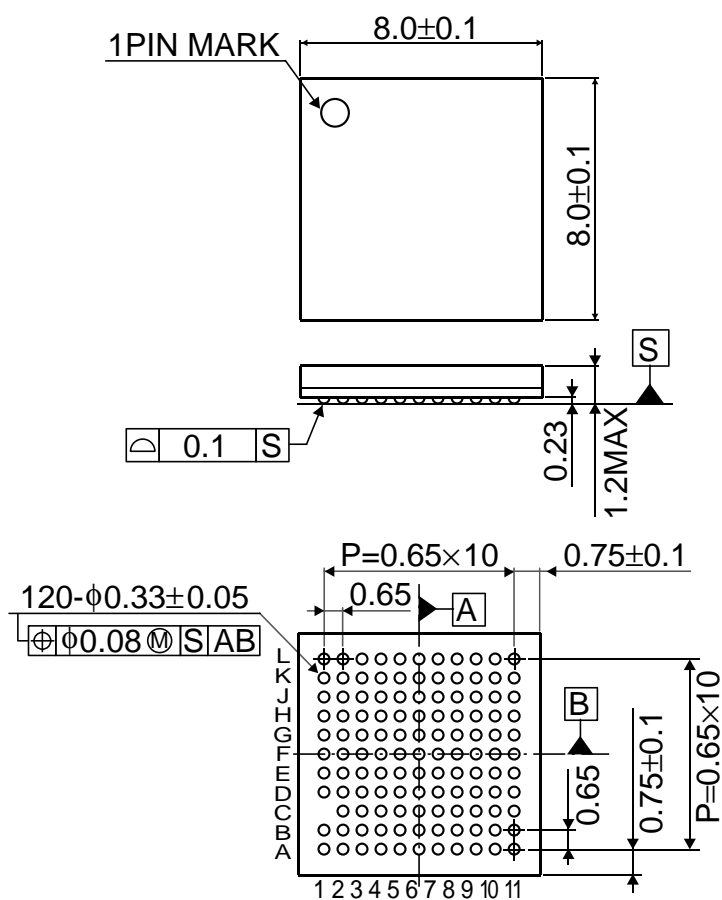
Package Dimensions

SBGA099T070

(Unit : mm)

Package Dimensions

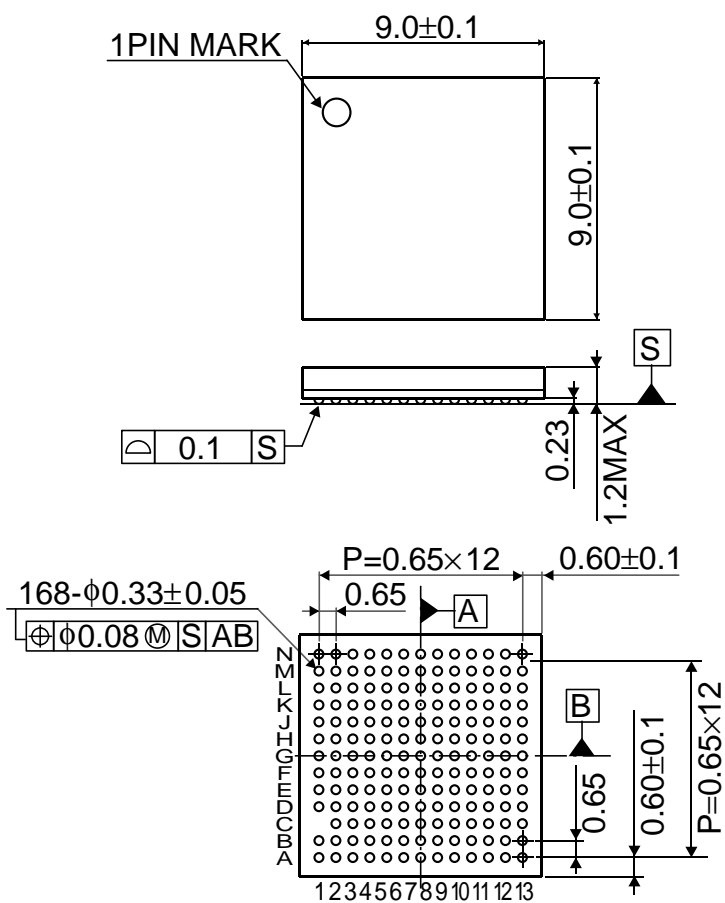
SBGA120T080



(Unit : mm)

Package Dimensions

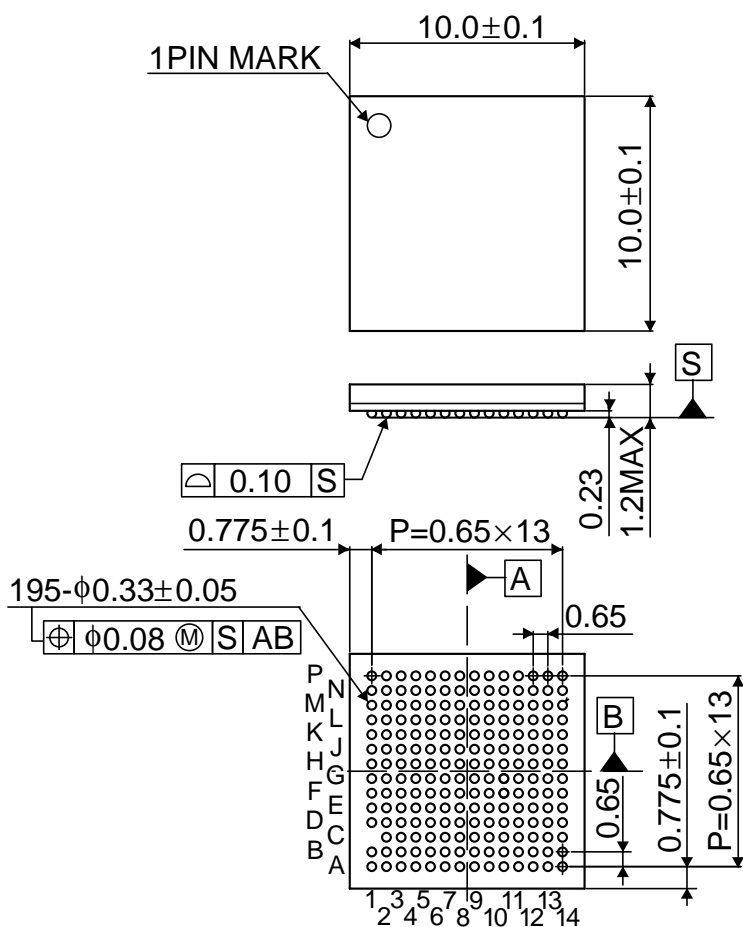
SBGA168T090



(Unit : mm)

Package Dimensions

SBGA195T100



(Unit : mm)

Notes

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